

CoreFocus Report

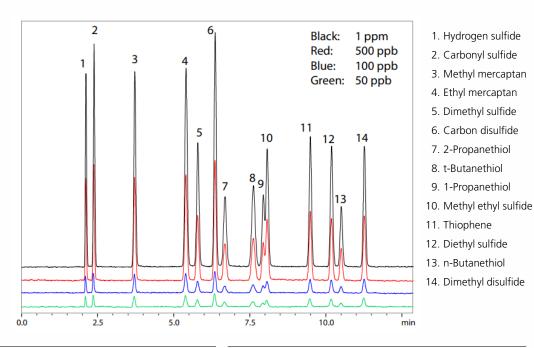
No.324

GC SCD **Gas Sampler SH Series**

SH-1

Analysis of Sulfur Compounds in Natural Gas According to ASTM D5504

Keywords: ASTM D5504, Sulfur compounds, Natural gas



Main Unit Nexis™ GC-2030 6-port Valve (Restek) Valve

Sample Loop Volume 1 mL Injector SPI

SH-1 (60 m x 0.53 mm I.D. df = $7 \mu m$), Column

P/N: 227-36108-02

Deactivated Fused Silica Tubing Post Column

(0.3 m x 0.32 mm) Detector SCD-2030 150 °C

Injection Temp. Split Ratio 1:9 (10 % to column) Carrier Gas : He

Carrier Gas Control : Constant Column Flow Mode (6.0 mL/min) : 30 °C(1.5 min) -10 °C/min - 200 °C (3 min) Column Temp.

Interface Temp . : 200 °C Furnace Temp. H₂ flow rate : 100 mL/min N₂ flow rate : 10 mL/min O₂ flow rate : 12 mL/min O₃ flow rate : 25 mL/min

Source: Application News G306 (JP, ENG)

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